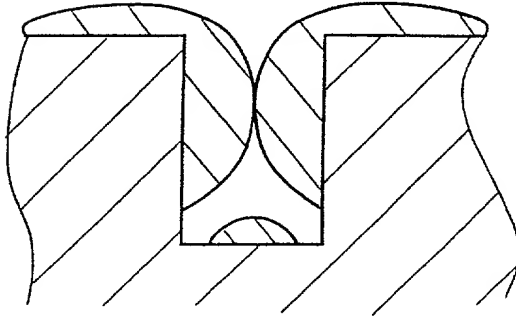
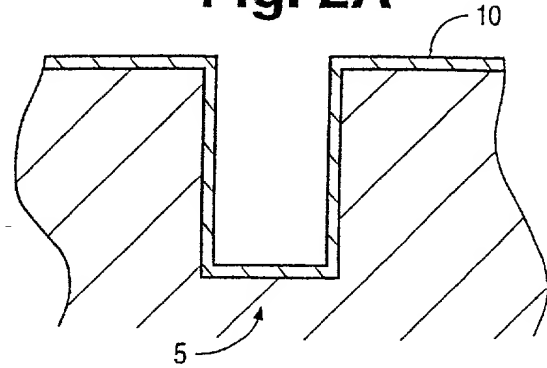


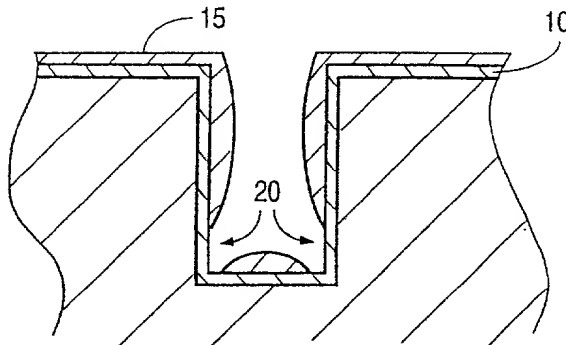
**Fig. 1**



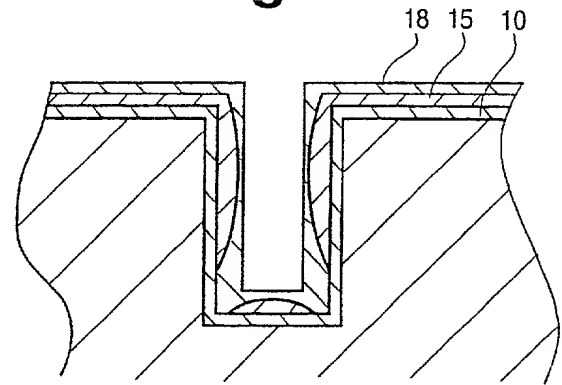
**Fig. 2A**



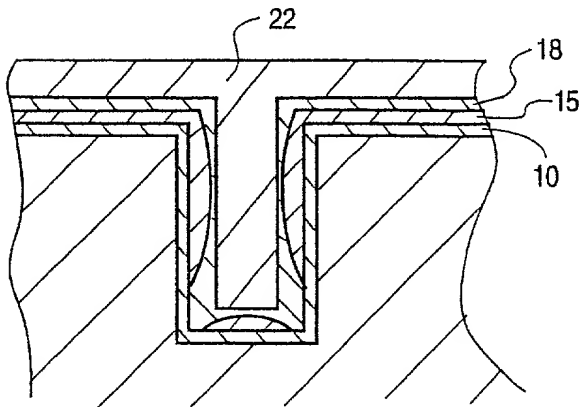
**Fig. 2B**



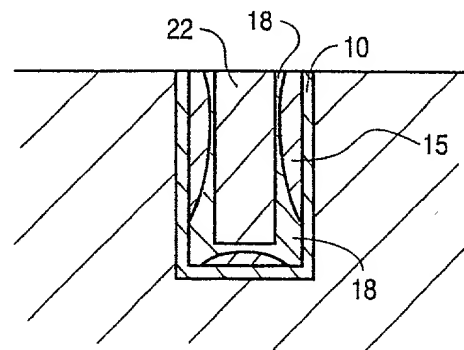
**Fig. 2C**



**Fig. 2D**

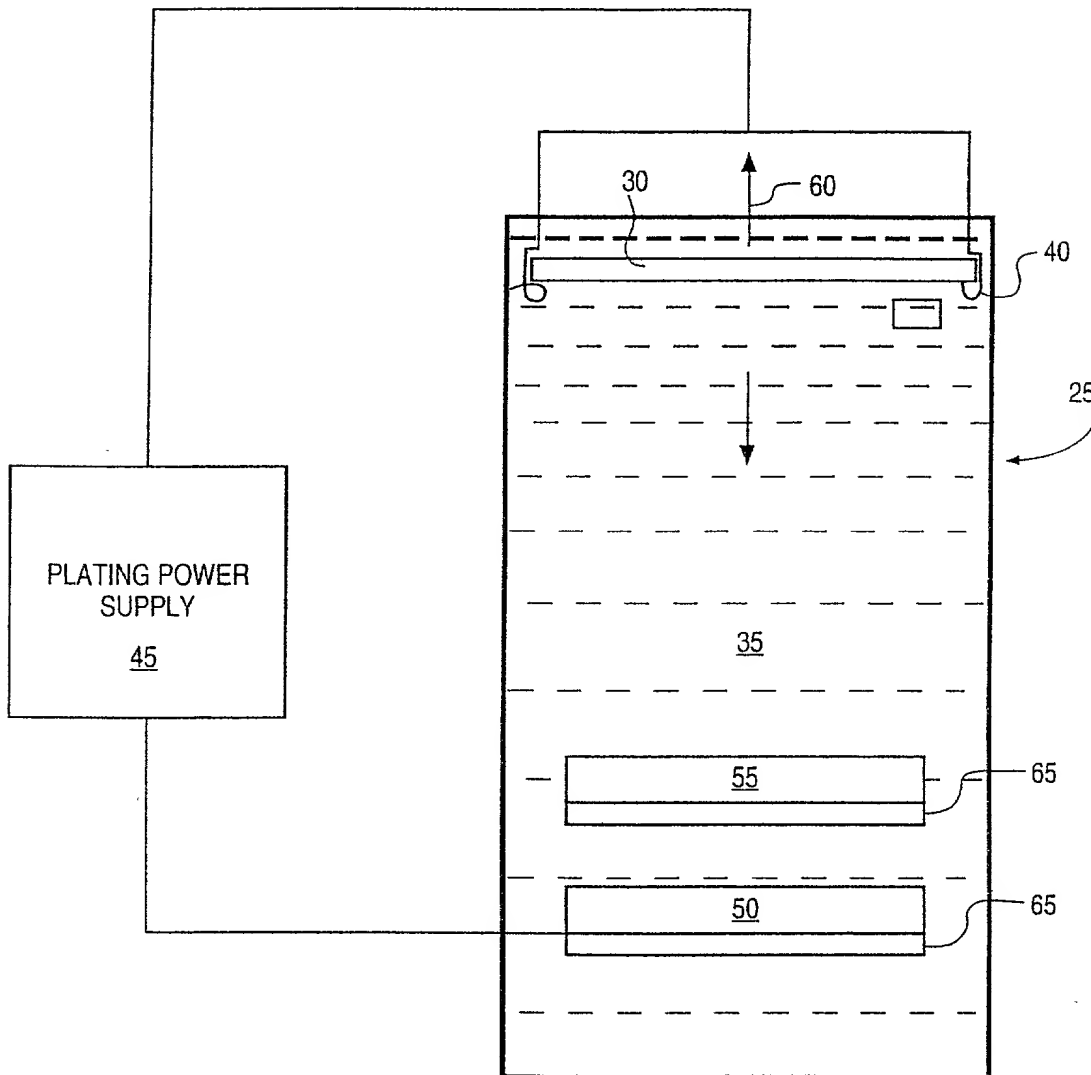


**Fig. 2E**

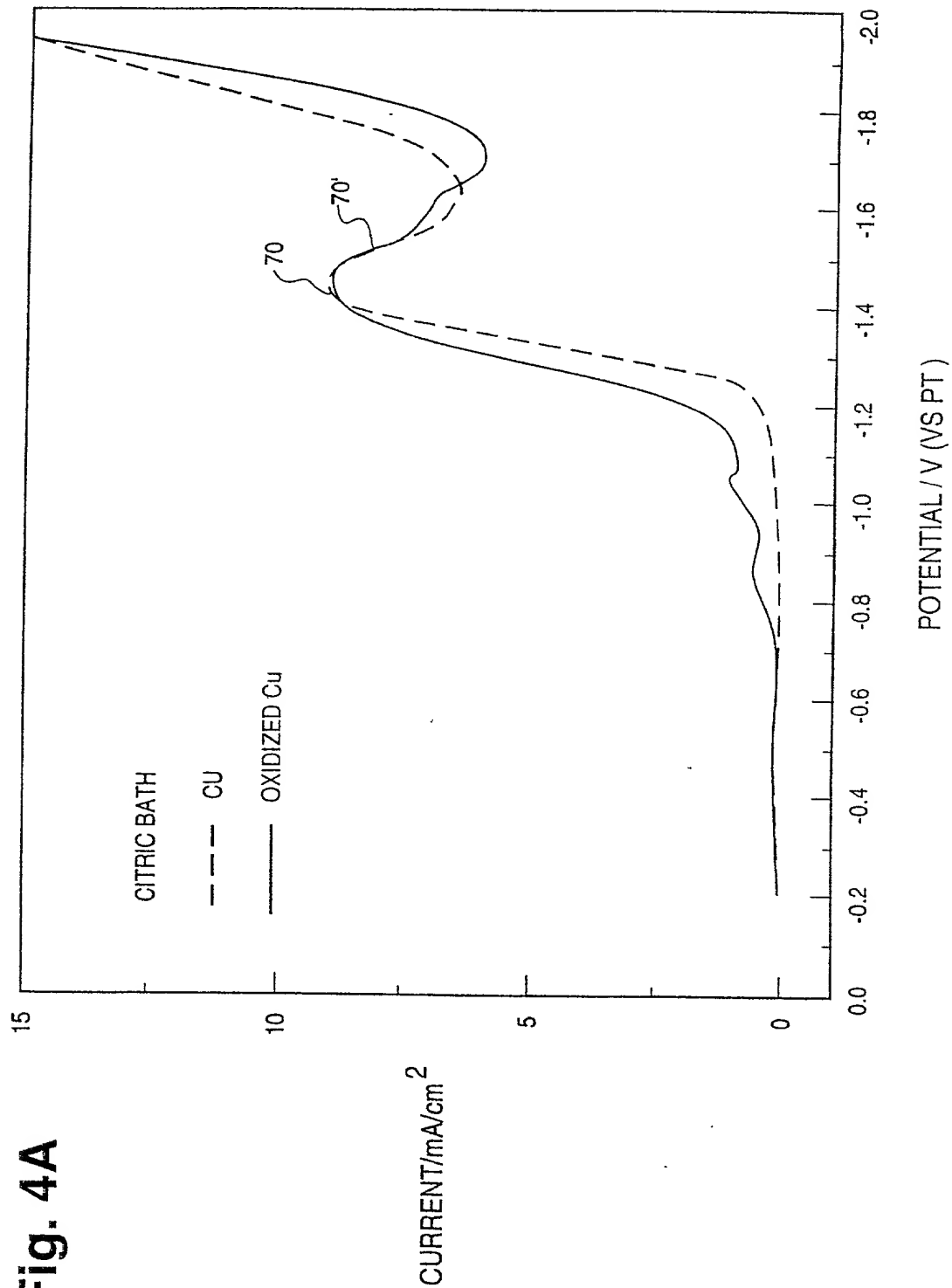


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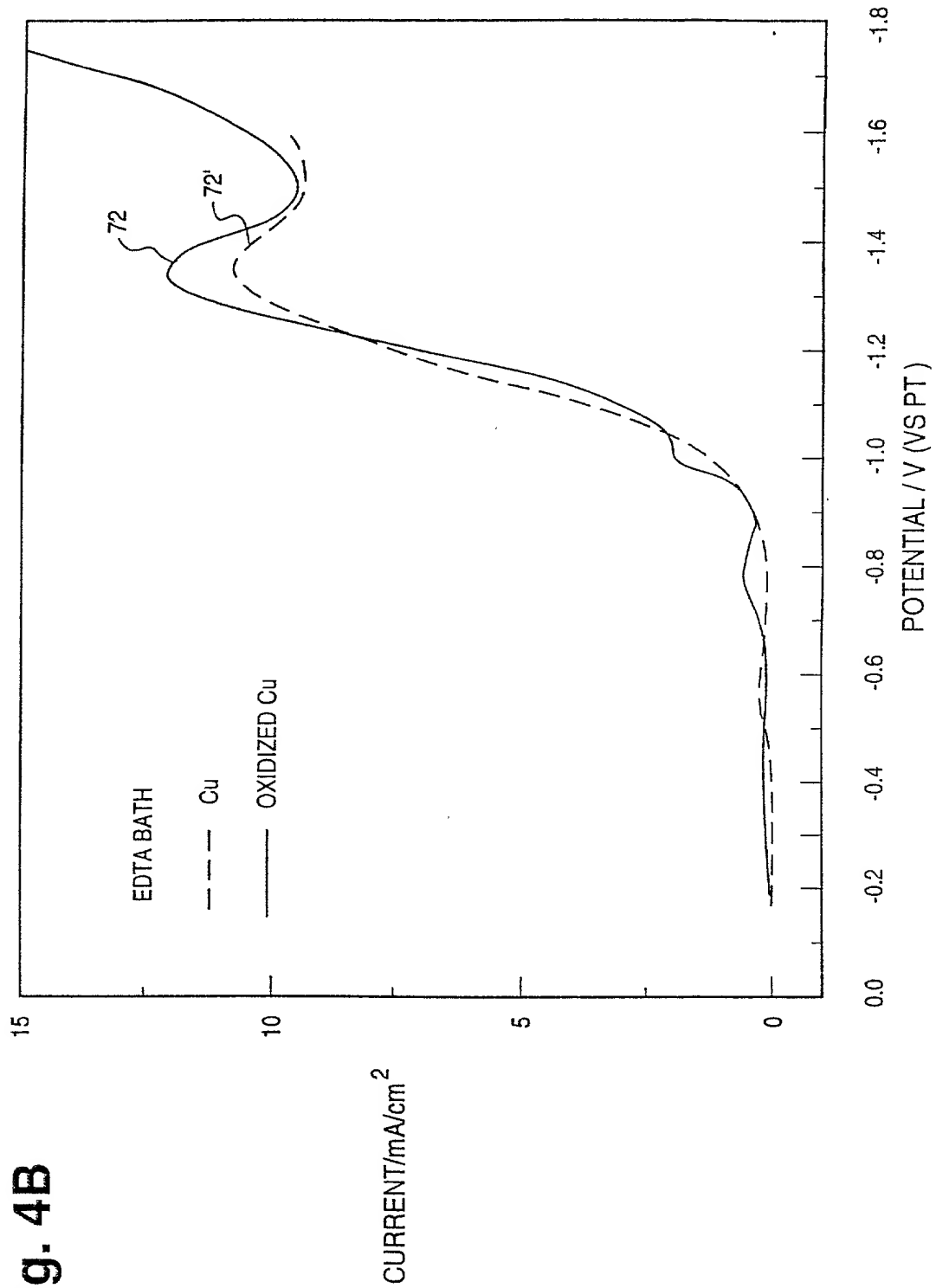
Fig. 3



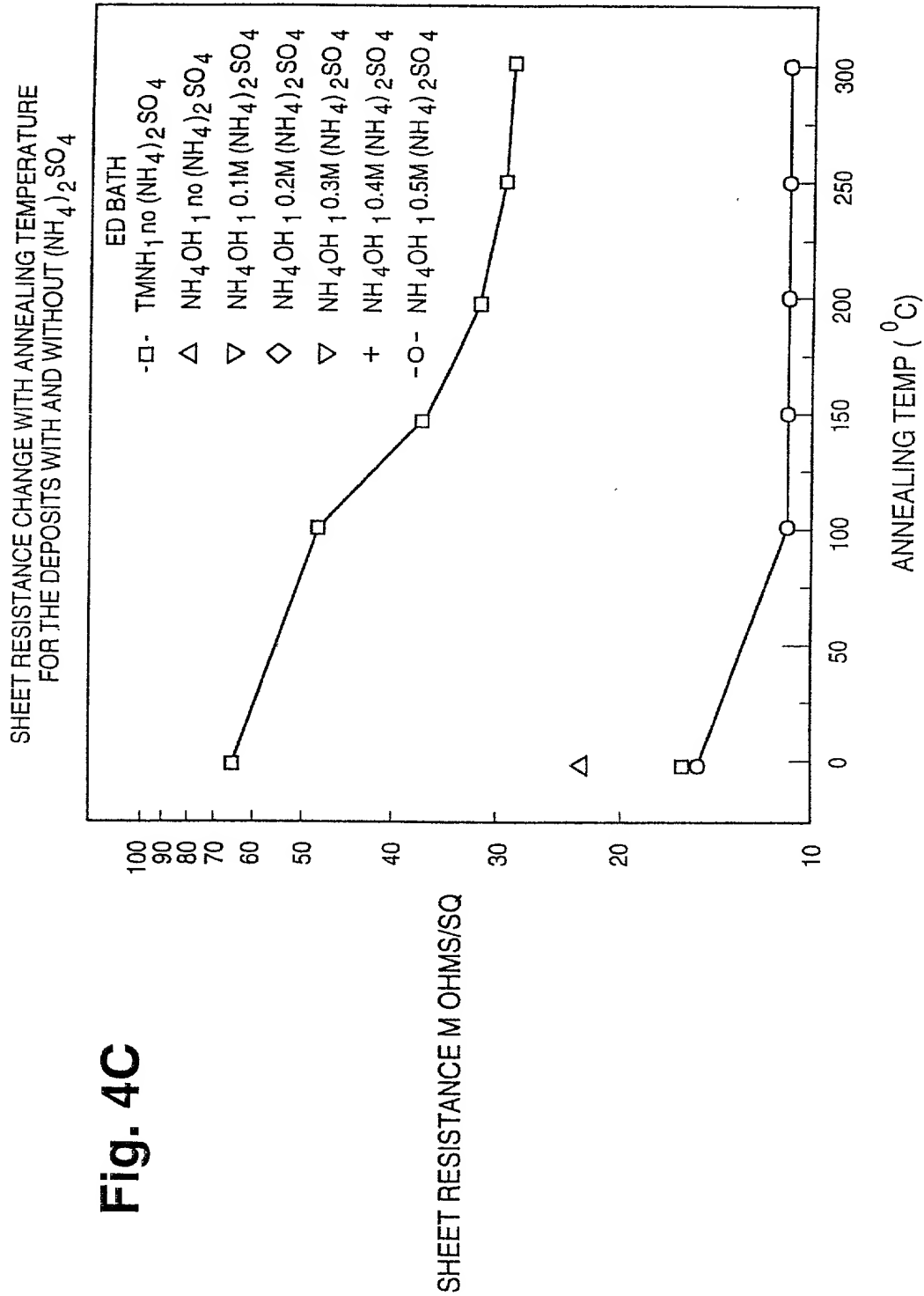
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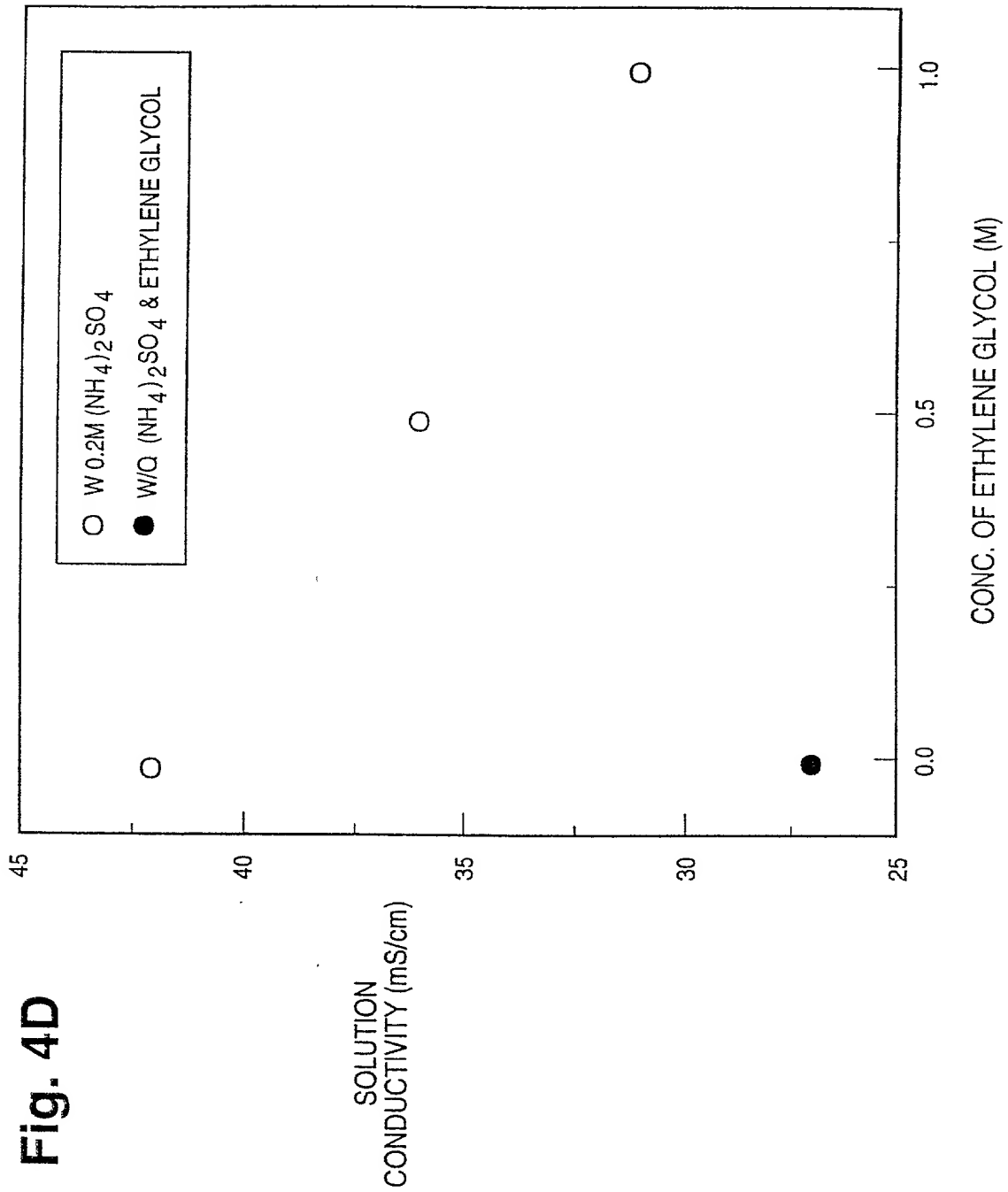
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Title: APPARATUS AND METHOD FOR  
ELECTROLYTICALLY DEPOSITING COPPER ON A  
SEMICONDUCTOR WORKPIECE

Inventor: L. Chen  
Docket No.: SEMT117581

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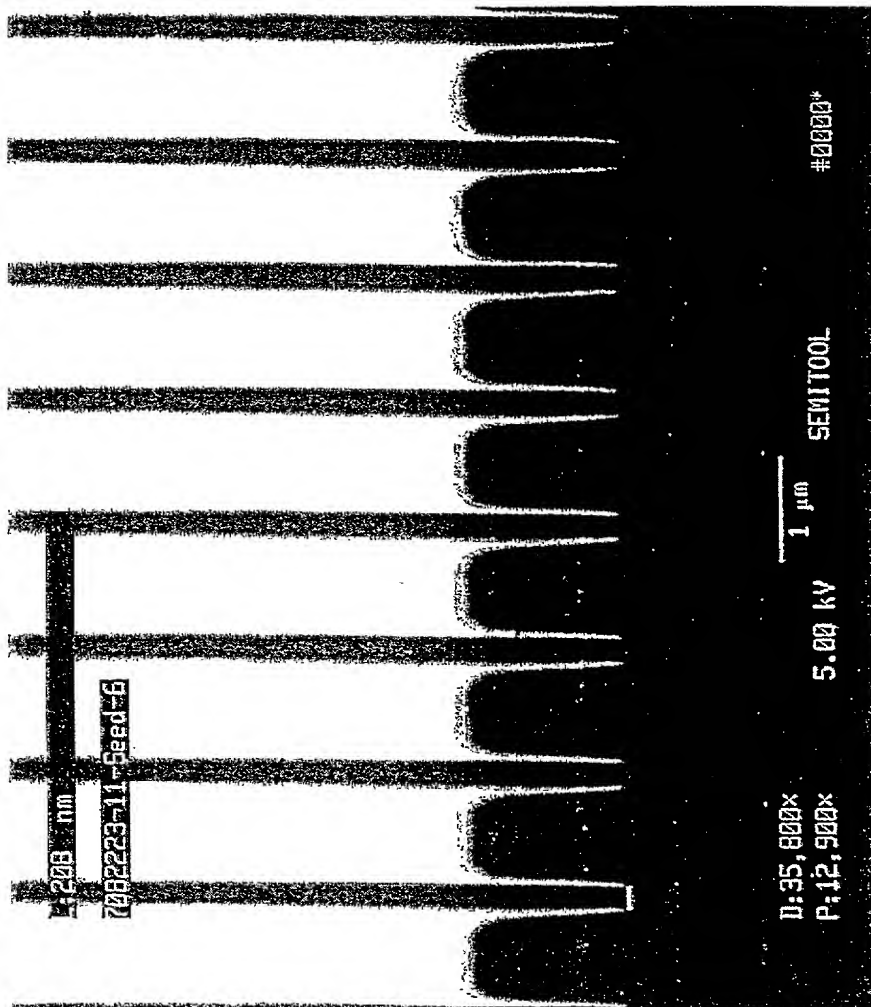


Fig. 5

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Inventor: L. Chen  
Docket No.: SEMT117581

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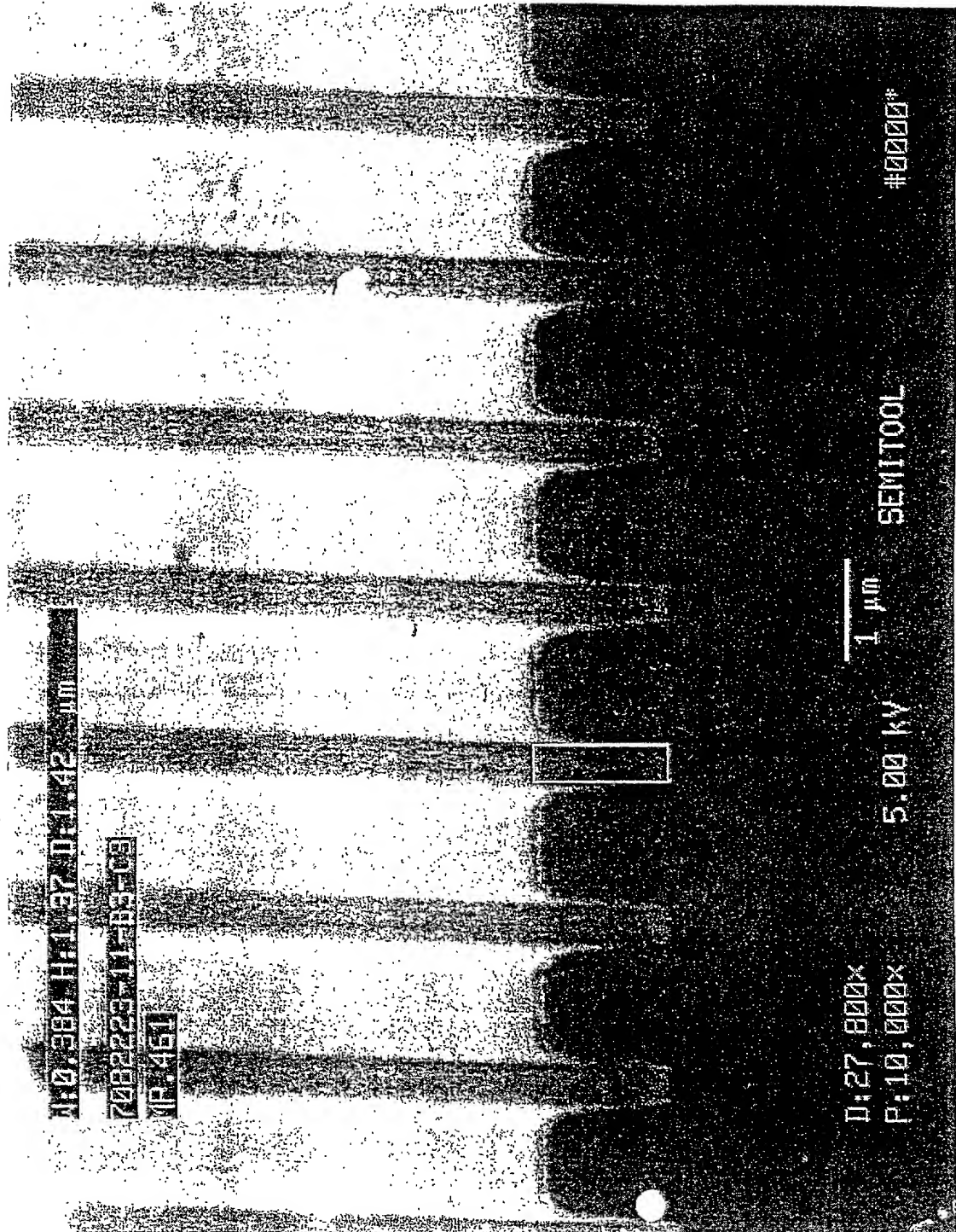


Fig. 6A



Title: APPARATUS AND METHOD FOR  
ELECTROLYTICALLY DEPOSITING COPPER ON A  
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Inventor: L. Chen  
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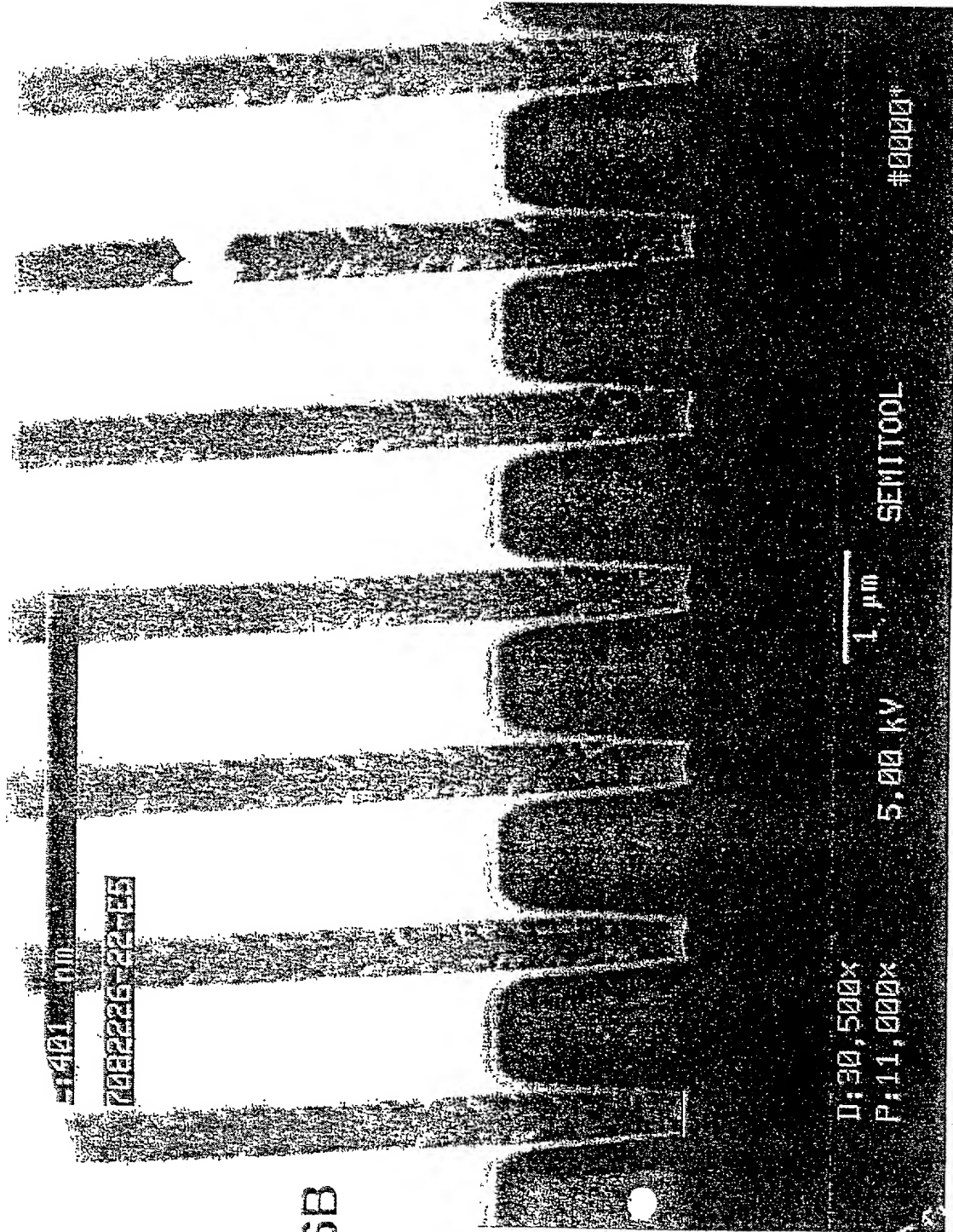


Fig. 6B

**Fig. 7**

